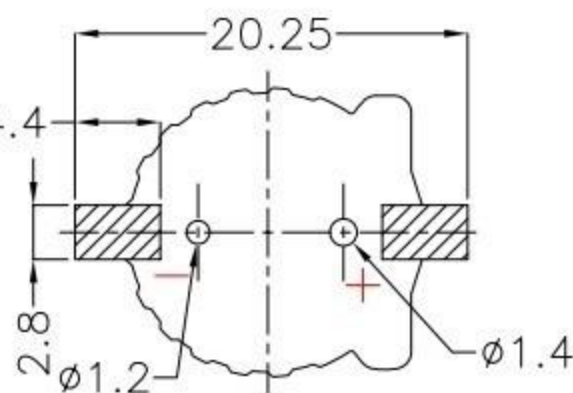
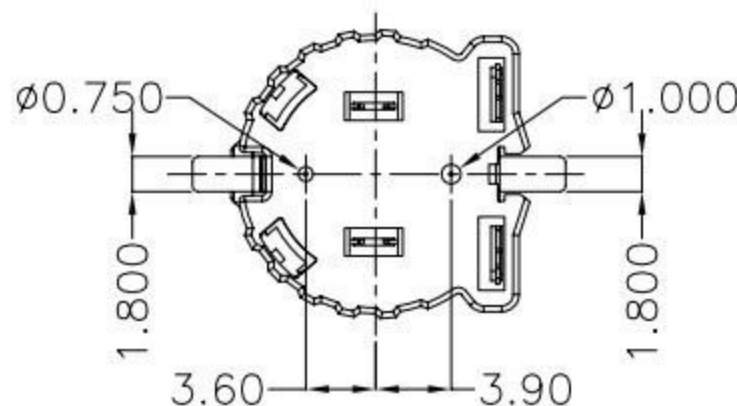
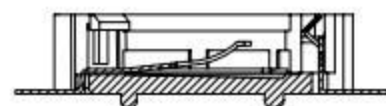
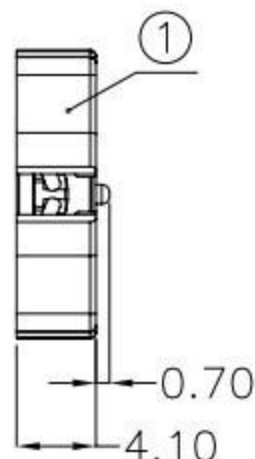
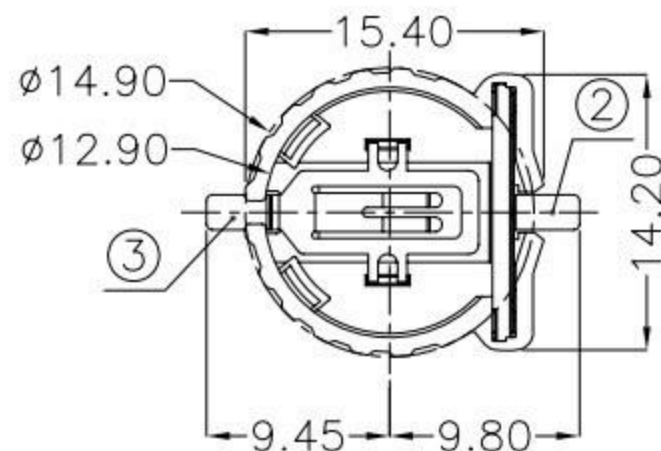




REV.	ECN NO.	REVISED	DATE



PCB Layout Diagram
Top View

1.MATERIAL:

- a.HOUSING:PPA
- b.CONTACT:PHOSPHOR BRONZE
(SURFACE PLATING:AU1u")

SEE ORDERING INFORMATION

2.ELECTRIC:

- a.CONTACT RESISTANCE: 30 MILLIOHMS MAX
- b.INSULATION RESISTANCE: 1000 MEGA OHMS MIN
- c.DIELECTRIC VOLTAGE: 500V AC ONE SEC LEVEL
- d.OPERATING TEMPERATURE: -25°C~ +85°C

ORDERING INFORMATION

电池座系列

SMT 180° TYPE

PLATING:
A-Au1U"
J-Ni100U"~120U"
K-Sn100U"~120U"

MATERIAL:
1A-PBT BLACK
1B-PA66 BLACK
2A-PPA BROWN
2B-PPA BLACK
3A-PPS BROWN
3B-PPS BLACK
4A-LCP WHITE
4B-LCP BLACK

3	TERMINAL(-)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
2	TERMINAL(+)	1	PHOSPHOR BRONZE, T=0.20mm	Gold Plating and Ni Under-Plating
1	HOUSING	1	PPA	BROWN
NO.	PART NAME	Q'TY	MATERIAL	PLATING & COLOR

UNLESS OTHERWISE
SPECIFIED TOLERANCES

DECIMALS: ANGLES:
X :±0.30 X :±1°
X.X :±0.25 X.X :±0.5°
X.XX :±0.20
X.XXX :±0.10

WEIGHT: 1.91g

SHEET 1 OF 1



东莞市溪榜电子有限公司
DONG GUAN XI BANG ELECTRONICS CO., LTD.

DSND	DATE	2017-07-13	TITLE:
CHKD	DATE	2017-07-13	
APVD	DATE	2017-07-13	PART NO.:
SCALE: 2:1	SIZE: A4	VIEW: ④ ⑤	
UNIT: mm	REV.: A/0	OBJECT: MY	DRAW NO.: